

Description

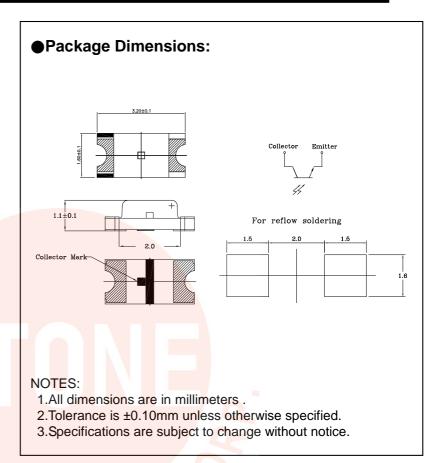
The BPT-HP033-TRB is a silicon NPN phototransistor detector in a 1206 SMD type package.

•Features:

- 1. Wide range of collector current.
- 2. Lend for high sensitivity.
- 3. Low cost plastic package
- 4. Lens Appearance: Water Clear
- 5. This product doesn't contain restriction Substance, comply ROHS standard.

Applications:

- 1. Smoke Detector
- 2. Automatic Control System
- 3. Any design requiring sensitivity and stable characteristics.



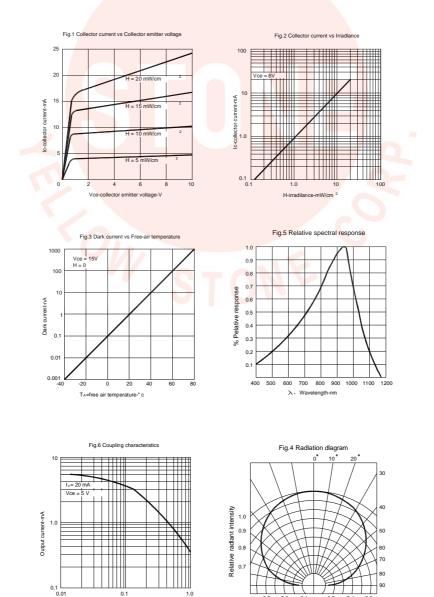
Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Operating Temperature	Topr	-40° ℃ ~85°℃	-
Storage Temperature	Tstg	-40 °C ~85 °C	-
Soldering Temperature	Tsol	See Page	-



● Electrical and optical characteristics(Ta=25°C)						
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Spectrum Sensitivity	λ		500	-	1000	nm
Short Circuit Current	λρ		-	940	-	nm
Collector Light Current	I _{C(ON)}	V _{CE} =5V, H=1.0mw/cm ²	0.557	1.5	-	mA
Collector Dark Current	I _{CEO}	V _{CE} =50V	-	-	100	nA
Rise/Fall Time	Tr/Tf	V_{CE} =5V, Ic=1mA, R _L =1K Ω	-	15/15	-	us
Veiwing Angle	20 _{1/2}		-	140	-	deg

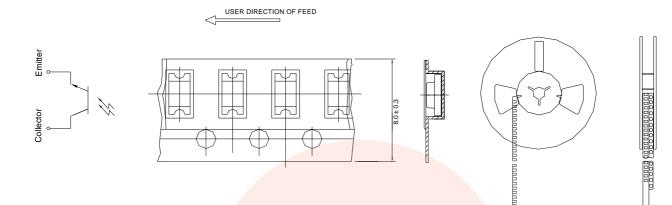
Typical Electro-Optical Characteristics Curves



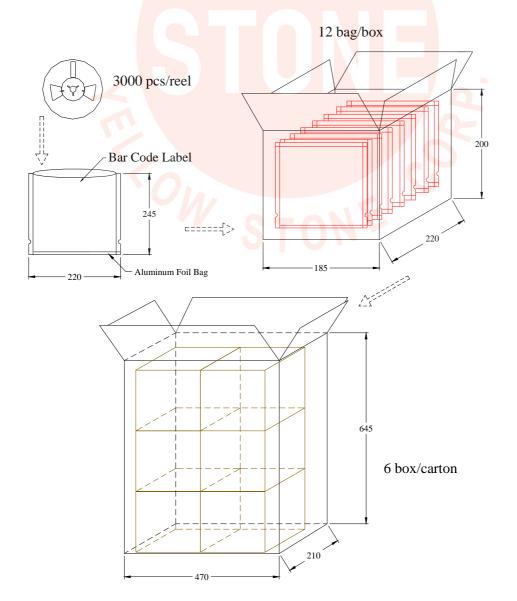
Distance between lenses-inches



Tapping and packaging specifications(Units: mm) Quantity:3000PCS



Package Method:(unit:mm) Vacuum





Bin Limits:

Collector Light Current Bin Limits

BIN CODE	Min. (mA)	Max. (mA)
Н	0.557	0.803
J	0.803	1.156
К	1.156	1.665
L	1.665	2.398

Tolerance for each Bin limit is $\pm 15\%$.





Reliability		Deference Oter	مامعما	Test Conditions	Deault
Classification	Test Item	Reference Stan		Test Conditions	Resul
Endurance	_			Ta: Under room temperature	
	Operation Life	MIL-STD-883D:1005		Test time:1,000hrs	
		JIS-C-7021 :B	6-1	IF=Product Recommended IF	
	High				
		MIL-STD-202F:1		Ta:85±5℃	0/32
	High Humidity	JIS-C-7021 :B-11		RH:90%-95%	0,02
Test	Storage			Test time:240hrs	
	High	MIL-STD-883:1008 JIS-C-7021 :B-10		Ta:100±5℃	
	Temperature			Test time:1,000hrs	0/32
	Storage		-		
	Low			Ta: -45±5℃	
	Temperature	JIS-C-7021 :B	-11	Test time=1,000hrs	0/32
	Storage				
	Temperature Cycling	MIL-STD-202F:1			
		MIL-STD-750D:1051		Ta:-35±5℃~25±5℃~85±5℃~25±5℃	
				30min 5min 30min 5min	0/32
			-2	Time: 5cycles	
	Thermal Shock	MIL-STD-202F:1	`	Ta:-45±5℃ ~+85±5℃	
		MIL-STD-750D:1051(20min 20 min	
				Time: 10cycles	0/32
Environmental		95)			
Test		MIL-STD-883D:1	011(1		
		991)			
		MIL-STD-883:20	03	T	
	Wetting	MIL-STD-202 <mark>F:2</mark> 08 <mark>D</mark> MIL-STD-883D:2003		Ta:230±5℃	0/32
	balance			Time:5±0.5s	
		MIL-STD-883D-1011		Ta:260±10℃ Time:10±1s	
	Solder				
	Resistance				

• Judgment criteria of failure for the reliability

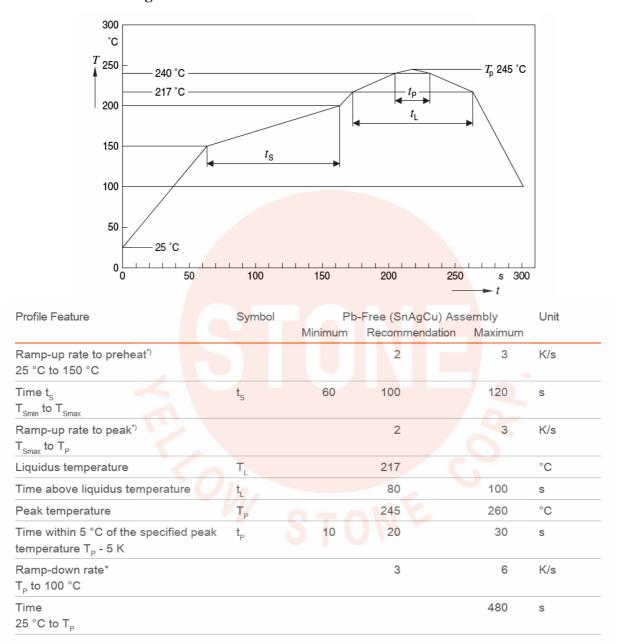
Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	I _F =20mA	Initial Level*1.1
Reverse current	I _R (uA)	V _R =5V	Over U*2
Luminous intensity	Iv (mcd)	I _F =20mA	Initial Level*0.7

Note: 1.U means the upper limit of specified characteristics.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.







All temperatures refer to the center of the package, measured on the top of the component * slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process.
- 3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs.

IRON Soldering

350°C Within 3 sec.,One time only.



Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LEDs within the rated figures. Also, caution should be taken not to overload LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the LEDs.

Storage:

In order to avoid the absorption of moisture, it is recommended to solder LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5° C 30° C (41° F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be: a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at 60° C ± 3° C.

Package and Label of Products:

- (1) Package: Products are packed in one bag of 3000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:

STONE 早安股份有限公司 ST	
Part No.:BL-Hxxxxx-TRB Quantity:xxxx HIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	— Part No. — Quantity — BIN.
Sealing date:xxxxx	— Sealing Date X XX XX ↑ Year Cycle ture Location